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[International Rectifier \(Infineon Technologies Americas Corp.\)](#)  
[IRF7220TRPBF](#)

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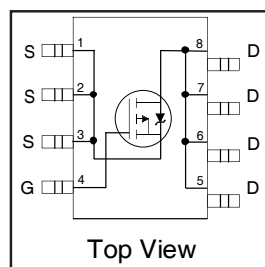
International  
**IR** Rectifier

PD - 95172

**IRF7220PbF**

HEXFET® Power MOSFET

- Ultra Low On-Resistance
- P-Channel MOSFET
- Surface Mount
- Available in Tape & Reel
- Lead-Free

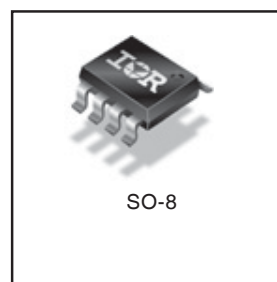


|                            |
|----------------------------|
| $V_{DS} = -14V$            |
| $R_{DS(on)} = 0.012\Omega$ |

### Description

These P-Channel MOSFETs from International Rectifier utilize advanced processing techniques to achieve the extremely low on-resistance per silicon area. This benefit provides the designer with an extremely efficient device for use in battery and load management applications.

The SO-8 has been modified through a customized leadframe for enhanced thermal characteristics and multiple-die capability making it ideal in a variety of power applications. With these improvements, multiple devices can be used in an application with dramatically reduced board space. The package is designed for vapor phase, infrared, or wave soldering techniques.



### Absolute Maximum Ratings

|                          | Parameter                                  | Max.         | Units |
|--------------------------|--|--------------|-------|
| $V_{DS}$                 | Drain- Source Voltage                      | -14          | V     |
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ -4.5V$ | $\pm 11$     | A     |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current, $V_{GS} @ -4.5V$ | $\pm 8.8$    |       |
| $I_{DM}$                 | Pulsed Drain Current ①                     | $\pm 88$     |       |
| $P_D @ T_A = 25^\circ C$ | Power Dissipation                          | 2.5          | W     |
| $P_D @ T_A = 70^\circ C$ | Power Dissipation                          | 1.6          |       |
|                          | Linear Derating Factor                     | 0.02         | W/°C  |
| $E_{AS}$                 | Single Pulse Avalanche Energy④             | 110          | mJ    |
| $V_{GS}$                 | Gate-to-Source Voltage                     | $\pm 12$     | V     |
| $T_J, T_{STG}$           | Junction and Storage Temperature Range     | -55 to + 150 | °C    |

### Thermal Resistance

|                 | Parameter                    | Max. | Units |
|-----------------|------------------------------|------|-------|
| $R_{\theta JA}$ | Maximum Junction-to-Ambient③ | 50   | °C/W  |

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# IRF7220PbF

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## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

|                                 | Parameter                            | Min.  | Typ.   | Max.  | Units               | Conditions   |
|---------------------------------|--------------------------------------|-------|--------|-------|---------------------|--|
| $V_{(BR)DSS}$                   | Drain-to-Source Breakdown Voltage    | -14   | —      | —     | V                   | $V_{GS} = 0V, I_D = -5mA$                              |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient  | —     | -0.006 | —     | V/ $^\circ\text{C}$ | Reference to $25^\circ\text{C}$ , $I_D = -1mA$         |
| $R_{DS(on)}$                    | Static Drain-to-Source On-Resistance | —     | .0082  | 0.012 | $\Omega$            | $V_{GS} = -4.5V, I_D = -11A$ ②                         |
|                                 |                                      | —     | .0125  | 0.020 |                     | $V_{GS} = -2.5V, I_D = -8.8A$ ②                        |
| $V_{GS(th)}$                    | Gate Threshold Voltage               | -0.60 | —      | —     | V                   | $V_{DS} = V_{GS}, I_D = -250\mu A$                     |
| $g_{fs}$                        | Forward Transconductance             | 8.4   | —      | —     | S                   | $V_{DS} = -10V, I_D = -11A$                            |
| $I_{DSS}$                       | Drain-to-Source Leakage Current      | —     | —      | -5.0  | $\mu A$             | $V_{DS} = -11.2V, V_{GS} = 0V$                         |
|                                 |                                      | —     | —      | -100  |                     | $V_{DS} = -11.2V, V_{GS} = 0V, T_J = 70^\circ\text{C}$ |
| $I_{GSS}$                       | Gate-to-Source Forward Leakage       | —     | —      | -100  | nA                  | $V_{GS} = -12V$  |
|                                 | Gate-to-Source Reverse Leakage       | —     | —      | 100   |                     | $V_{GS} = 12V$   |
| $Q_g$                           | Total Gate Charge                    | —     | 84     | 125   | nC                  | $I_D = -11A$   |
| $Q_{gs}$                        | Gate-to-Source Charge                | —     | 13     | 20    |                     | $V_{DS} = -10V$  |
| $Q_{gd}$                        | Gate-to-Drain ("Miller") Charge      | —     | 37     | 55    |                     | $V_{GS} = -5.0V$ ②                                     |
| $t_{d(on)}$                     | Turn-On Delay Time                   | —     | 19     | —     | ns                  | $V_{DD} = -10V$  |
| $t_r$                           | Rise Time                            | —     | 420    | —     |                     | $I_D = -11A$   |
| $t_{d(off)}$                    | Turn-Off Delay Time                  | —     | 140    | —     |                     | $R_G = 6.2\Omega$                                      |
| $t_f$                           | Fall Time                            | —     | 1040   | —     |                     | $R_D = 0.91\Omega$ ②                                   |
| $C_{iss}$                       | Input Capacitance                    | —     | 8075   | —     | pF                  | $V_{GS} = 0V$  |
| $C_{oss}$                       | Output Capacitance                   | —     | 4400   | —     |                     | $V_{DS} = -10V$  |
| $C_{rss}$                       | Reverse Transfer Capacitance         | —     | 4150   | —     |                     | $f = 1.0MHz$   |

## Source-Drain Ratings and Characteristics

|          | Parameter                                 | Min. | Typ. | Max. | Units | Conditions  |
|----------|---|------|------|------|-------|---|
| $I_S$    | Continuous Source Current<br>(Body Diode) | —    | —    | -2.5 | A     | MOSFET symbol<br>showing the<br>integral reverse<br>p-n junction diode. |
| $I_{SM}$ | Pulsed Source Current<br>(Body Diode) ①   | —    | —    | -88  |       |   |
| $V_{SD}$ | Diode Forward Voltage                     | —    | —    | -1.2 | V     | $T_J = 25^\circ\text{C}, I_S = -2.5A, V_{GS} = 0V$ ②                    |
| $t_{rr}$ | Reverse Recovery Time                     | —    | 160  | 240  | ns    | $T_J = 25^\circ\text{C}, I_F = -2.5A$                                   |
| $Q_{rr}$ | Reverse Recovery Charge                   | —    | 147  | 220  | nC    | $di/dt = 100A/\mu s$ ②  |

### Notes:

① Repetitive rating; pulse width limited by max. junction temperature.

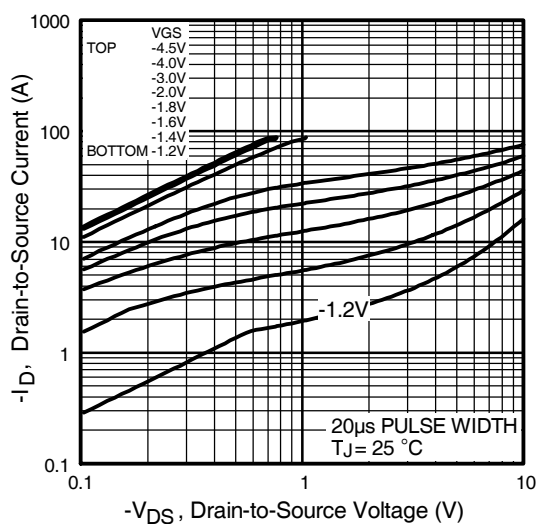
② Pulse width  $\leq 300\mu s$ ; duty cycle  $\leq 2\%$ .

③ When mounted on 1 inch square copper board,  $t < 10$  sec

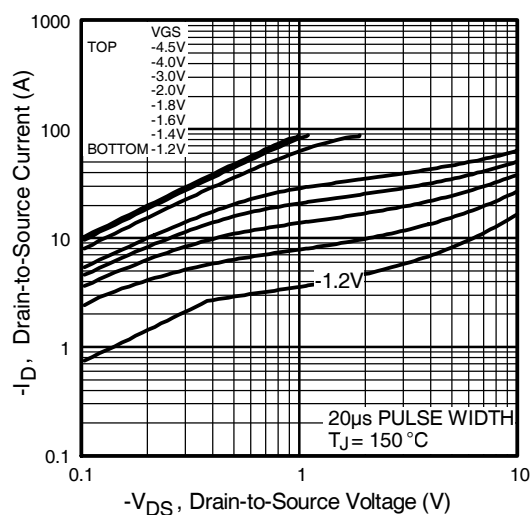
④ Starting  $T_J = 25^\circ\text{C}$ ,  $L = 1.8mH$   
 $R_G = 25\Omega, I_{AS} = 11A$ . (See Figure 10)

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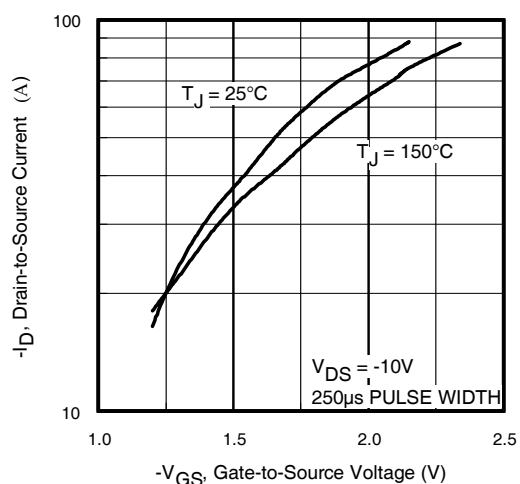
## IRF7220PbF



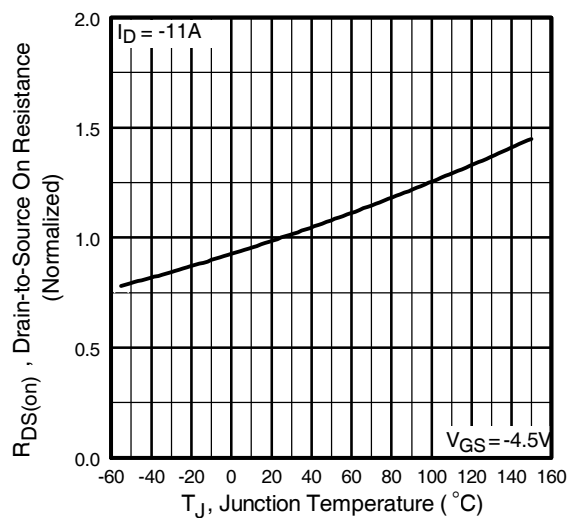
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics



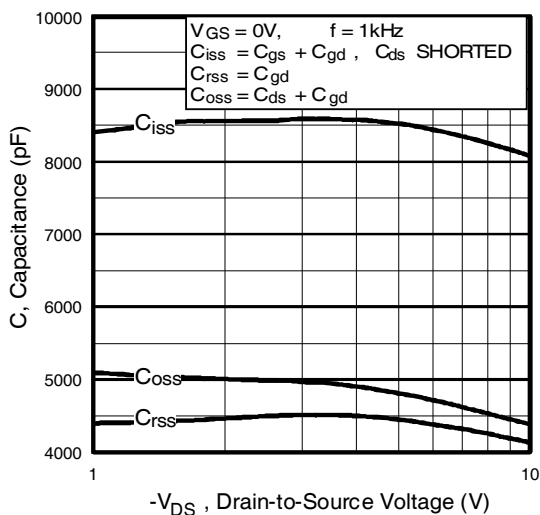
**Fig 3.** Typical Transfer Characteristics



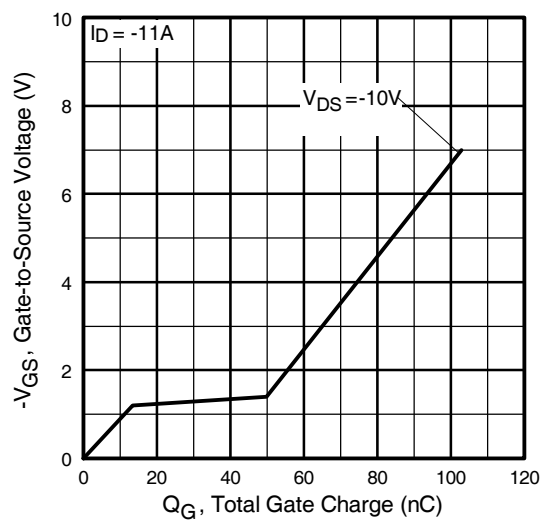
**Fig 4.** Normalized On-Resistance  
Vs. Temperature

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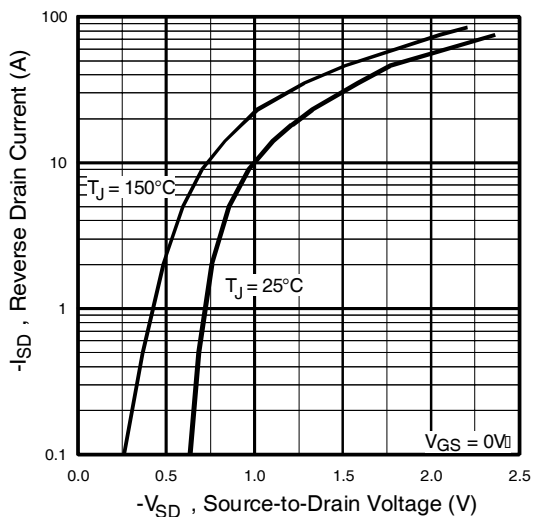
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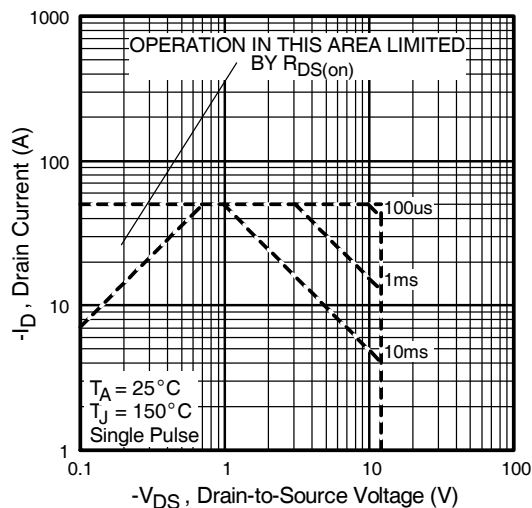
**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



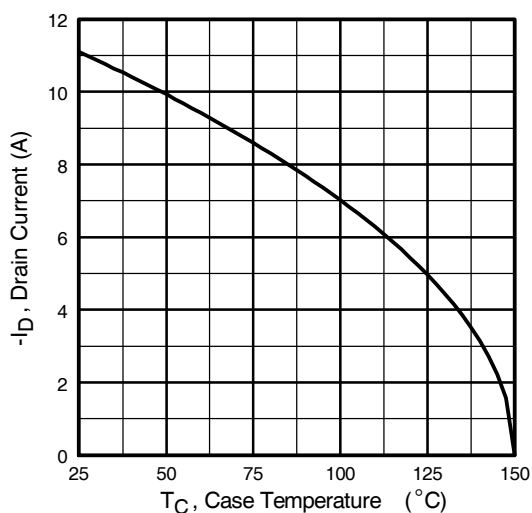
**Fig 7.** Typical Source-Drain Diode Forward Voltage



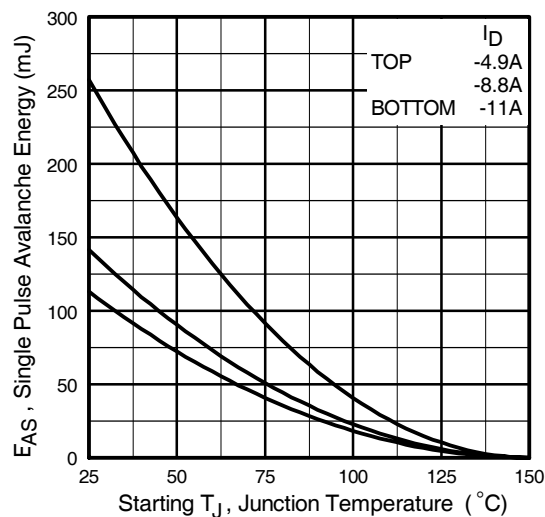
**Fig 8.** Maximum Safe Operating Area

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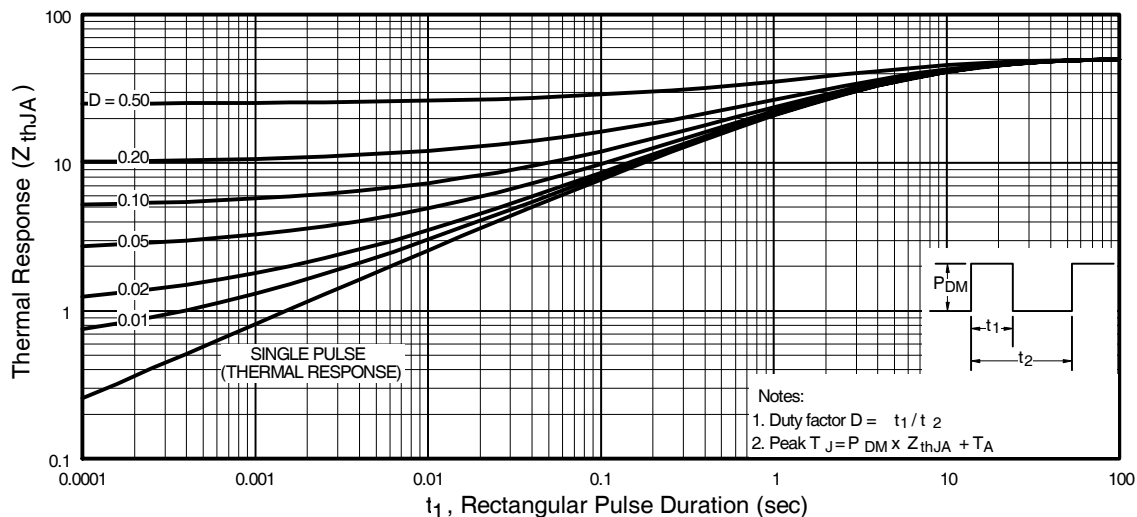
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**Fig 9.** Maximum Drain Current Vs. Case Temperature



**Fig 10.** Maximum Avalanche Energy Vs. Drain Current



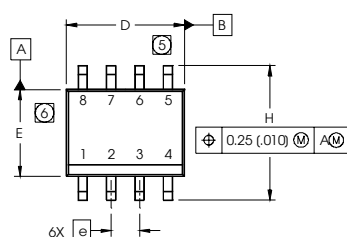
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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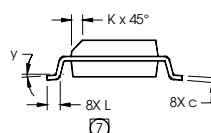
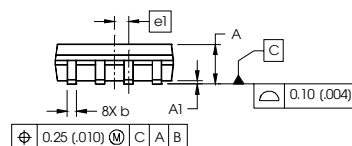
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## SO-8 Package Outline

Dimensions are shown in millimeters (inches)



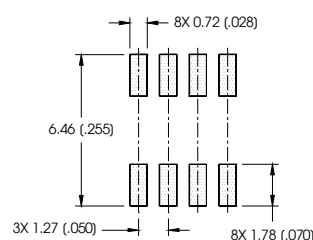
| DIM | INCHES     |       | MILLIMETERS |      |
|-----|------------|-------|-------------|------|
|     | MIN        | MAX   | MIN         | MAX  |
| A   | .0532      | .0688 | 1.35        | 1.75 |
| AI  | .0040      | .0098 | 0.10        | 0.25 |
| b   | .013       | .020  | 0.33        | 0.51 |
| c   | .0075      | .0098 | 0.19        | 0.25 |
| D   | .189       | .1968 | 4.80        | 5.00 |
| E   | .1497      | .1574 | 3.80        | 4.00 |
| e   | .050 BASIC |       | 1.27 BASIC  |      |
| e1  | .025 BASIC |       | 0.635 BASIC |      |
| H   | .2284      | .2440 | 5.80        | 6.20 |
| K   | .0099      | .0196 | 0.25        | 0.50 |
| L   | .016       | .050  | 0.40        | 1.27 |
| y   | 0°         | 8°    | 0°          | 8°   |



### NOTES:

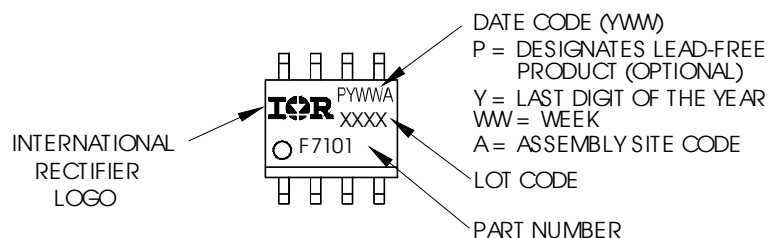
1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
5. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
6. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
7. DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

### FOOTPRINT



## SO-8 Part Marking Information (Lead-Free)

EXAMPLE: THIS IS AN IRF7101 (MOSFET)

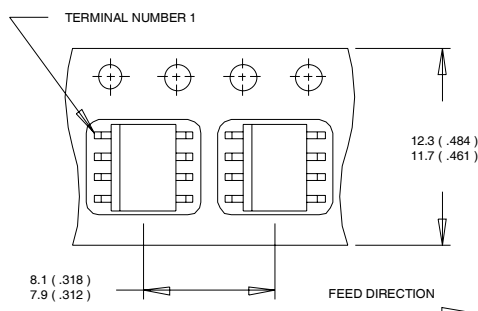


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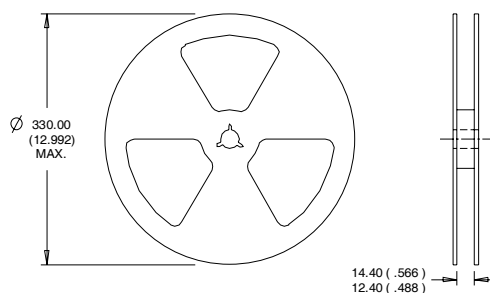
**IRF7220PbF**

## SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



NOTES:  
1. CONTROLLING DIMENSION : MILLIMETER.  
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).  
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :  
1. CONTROLLING DIMENSION : MILLIMETER.  
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice.  
This product has been designed and qualified for the Consumer market.  
Qualifications Standards can be found on IR's Web site.

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